

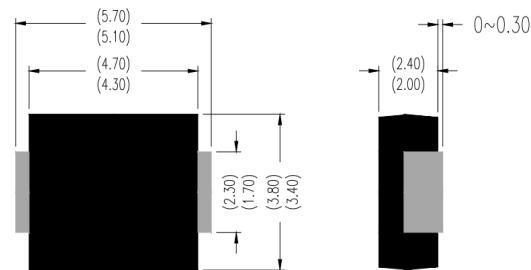


## Surface Mount Schottky Rectifier

### Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

### DO-214AA (SMB)

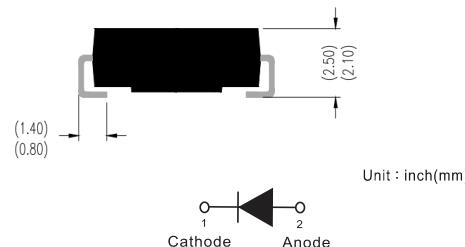


### Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### Mechanical Data

- **Package:** DO-214AA (SMB)  
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end



### ■ Maximum Ratings ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

| PARAMETER  | SYMBOL    | UNIT | SS22 | SS23 | SS24 | SS25 | SS26 | SS28      | SS210 | SS215 | SS220     |
|--|-----------|------|------|------|------|------|------|-----------|-------|-------|-----------|
| Repetitive peak reverse voltage  | $V_{RRM}$ | V    | 20   | 30   | 40   | 50   | 60   | 80        | 100   | 150   | 200       |
| Average rectified output current @60Hz sine wave, resistance load, TL (FIG.1)              | $I_o$     | A    |      |      |      |      |      | 2.0       |       |       |           |
| Surge(non-repetitive)forward current @60Hz half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$ | $I_{FSM}$ | A    |      |      |      |      |      | 50        |       |       |           |
| Storage temperature  | $T_{stg}$ | °C   |      |      |      |      |      | -55 ~+150 |       |       |           |
| Junction temperature   | $T_j$     | °C   |      |      |      |      |      | -55 ~+150 |       |       | -55 ~+175 |

### ■ Electrical Characteristics ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

| PARAMETER   | SYMBOL    | UNIT | TEST CONDITIONS        | SS22 | SS23 | SS24 | SS25 | SS26 | SS28 | SS210 | SS215 | SS220 |
|---|-----------|------|------------------------|------|------|------|------|------|------|-------|-------|-------|
| Maximum instantaneous forward voltage drop per diode                                | $V_F$     | V    | $I_{FM} = 2.0\text{A}$ |      | 0.55 |      | 0.70 |      | 0.85 |       | 0.95  |       |
| Maximum DC reverse current at rated DC blocking voltage per diode@ $V_{RM}=V_{RRM}$ | $I_{RRM}$ | mA   | Ta=25°C                |      |      | 0.50 |      |      | 0.10 |       |       |       |
|   |           |      | Ta=100°C               |      |      | 10   |      |      | 5    |       |       |       |

### ■ Thermal Characteristics ( $T_a=25^\circ\text{C}$ Unless otherwise specified)

| PARAMETER          | SYMBOL           | UNIT | SS22 | SS23 | SS24 | SS25              | SS26 | SS28 | SS210 | SS215 | SS220 |
|--------------------|------------------|------|------|------|------|-------------------|------|------|-------|-------|-------|
| Thermal resistance | $R_{\theta J-A}$ | °C/W |      |      |      | 75 <sup>(1)</sup> |      |      |       |       |       |
|                    | $R_{\theta J-L}$ |      |      |      |      | 17 <sup>(1)</sup> |      |      |       |       |       |

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas



## ■ Characteristics(Typical)

